HARRIS SEMICONDUCTOR

RHRP8120CC

April 1995

8A, 1200V Hyperfast Dual Diode

Features

- Hyperfast with Soft Recovery . . . . . <55ns
- Operating Temperature . . . . . +175°C
- Reverse Voltage 1200V
- Avalanche Energy Rated
- Planar Construction

Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

Description

The RHRP8120CC (TA49096) is a hyperfast dual diode with soft recovery characteristics (t_{RR} < 55ns). It has half the recovery time of ultrafast diodes and is silicon nitride passivated ion-implanted epitaxial planar construction.

This device is intended for use as a freewheeling/clamping diode and rectifier in a variety of switching power supplies and other power switching applications. Its low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

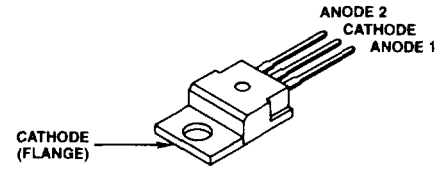
PACKAGING AVAILABILITY

PART NUMBER	PACKAGE	BRAND
RHRP8120CC	TO-220AB	RHR8120C

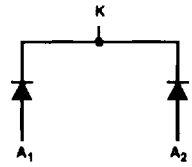
NOTE: When ordering, use the entire part number.

Package

JEDEC TO-220AB



Symbol



Absolute Maximum Ratings (per leg) T_C = +25°C, Unless Otherwise Specified

		RHRP8120CC	UNITS
Peak Repetitive Reverse Voltage	V_{RRM}	1200	V
Working Peak Reverse Voltage	V_{RWM}	1200	V
DC Blocking Voltage	V_R	1200	V
Average Rectified Forward Current (T_C = +140°C)	$I_{F(AV)}$	8	A
Repetitive Peak Surge Current (Square Wave, 20kHz)	I_{FSM}	16	A
Nonrepetitive Peak Surge Current (Halfwave, 1 Phase, 60Hz)	I_{FSM}	100	A
Maximum Power Dissipation	P_D	75	W
Avalanche Energy (See Figures 10 and 11)	E_{AVL}	20	mj
Operating and Storage Temperature	T_{STG}, T_J	-65 to +175	°C

8 HYPERFAST DUAL DIODES

File Number **3966.1**

Electrical Specifications (per leg) $T_C = +25^oC$, Unless Otherwise Specified

SYMBOL	TEST CONDITION	LIMITS			UNITS
		MIN	TYP	MAX	
V_F	I_F = 8A, T_C = +25°C	-	-	3.2	V
	I_F = 8A, T_C = +150°C	-	-	2.6	V
I_R	V_R = 1200V, T_C = +25°C	-	-	100	µA
	V_R = 1200V, T_C = +150°C	-	-	500	µA
t_{RR}	I_F = 1A, dI_F/dt = 200A/µs	-	-	55	ns
	I_F = 8A, dI_F/dt = 200A/µs	-	-	65	ns
t_A	I_F = 8A, dI_F/dt = 200A/µs	-	30	-	ns
t_B	I_F = 8A, dI_F/dt = 200A/µs	-	20	-	ns
Q_{RR}	I_F = 8A, dI_F/dt = 200A/µs	-	165	-	nC
C_J	V_R = 10V, I_F = 0A	-	25	-	pF
$R_{\theta JC}$		-	-	2	°C/W

DEFINITIONS

V_F = Instantaneous forward voltage (pw = 300µs, D = 2%).

I_R = Instantaneous reverse current.

t_{RR} = Reverse recovery time (See Figure 2), summation of $t_A + t_B$.

t_A = Time to reach peak reverse current (See Figure 2).

t_B = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 2).

Q_{RR} = Reverse recovery charge.

C_J = Junction Capacitance.

$R_{\theta JC}$ = Thermal resistance junction to case.

E_{AVL} = Controlled avalanche energy. (See Figures 10 and 11).

pw = pulse width.

D = duty cycle.

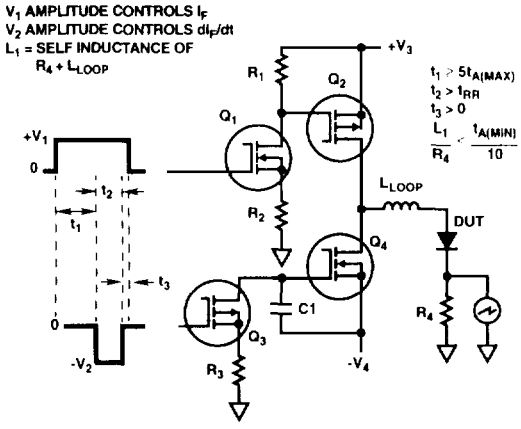


FIGURE 1. t_{RR} TEST CIRCUIT

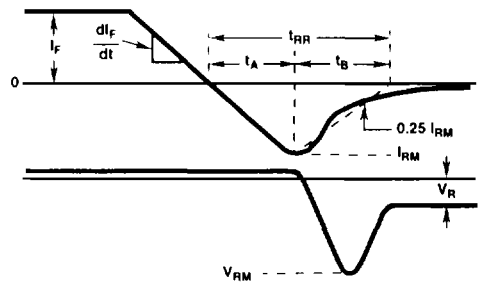


FIGURE 2. t_{RR} WAVEFORMS AND DEFINITIONS

Typical Performance Curves

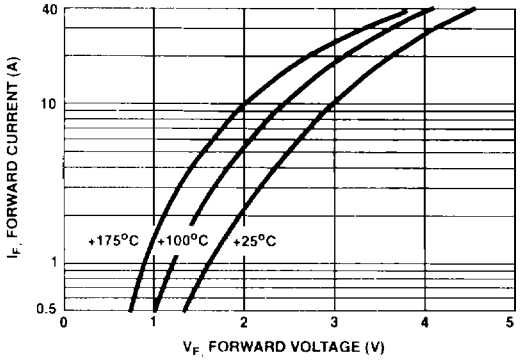


FIGURE 3. TYPICAL FORWARD CURRENT vs FORWARD VOLTAGE DROP

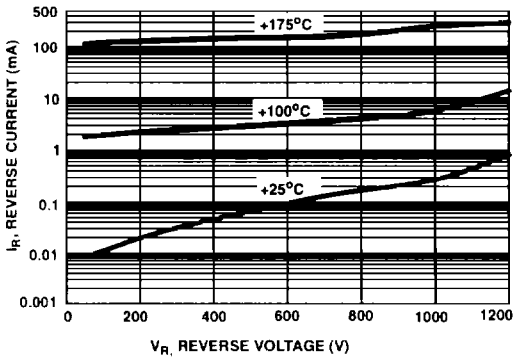


FIGURE 4. TYPICAL REVERSE CURRENT vs REVERSE VOLTAGE

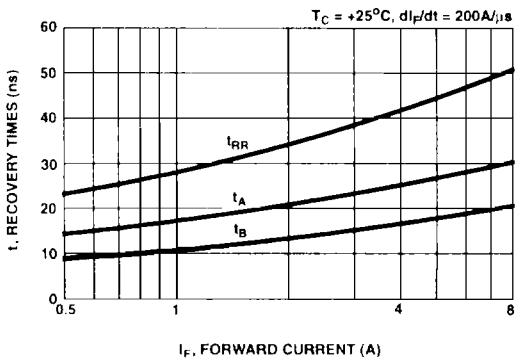


FIGURE 5. TYPICAL t_{RR}, t_A AND t_B CURVES vs FORWARD CURRENT AT +25°C

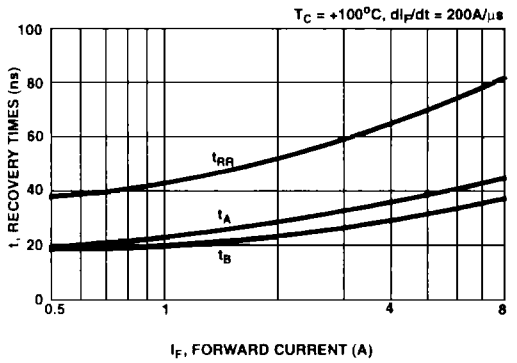


FIGURE 6. TYPICAL t_{RR}, t_A AND t_B CURVES vs FORWARD CURRENT AT +100°C

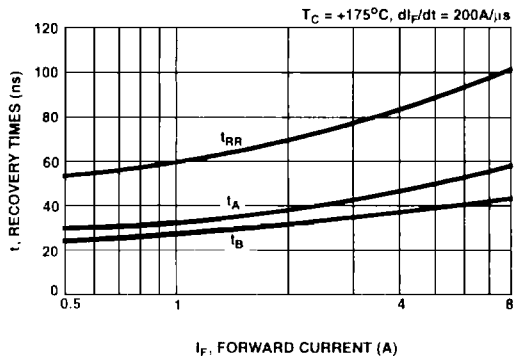


FIGURE 7. TYPICAL t_{RR}, t_A AND t_B CURVES vs FORWARD CURRENT AT +175°C

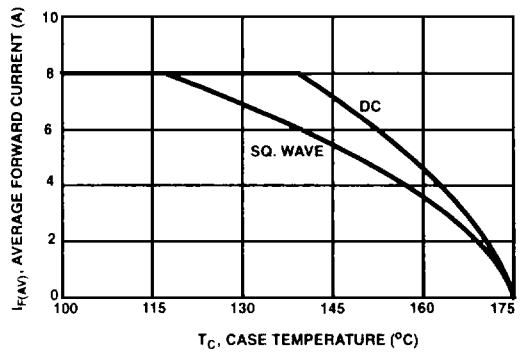


FIGURE 8. CURRENT DERATING CURVE

Typical Performance Curves (Continued)

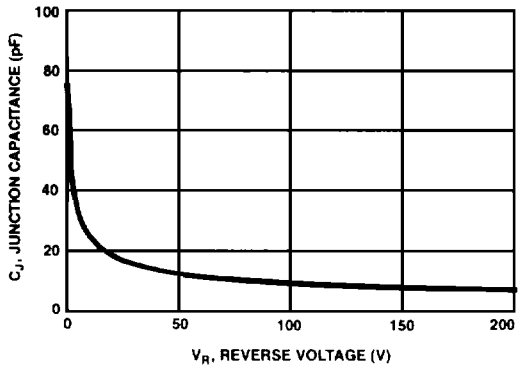


FIGURE 9. TYPICAL JUNCTION CAPACITANCE vs REVERSE VOLTAGE

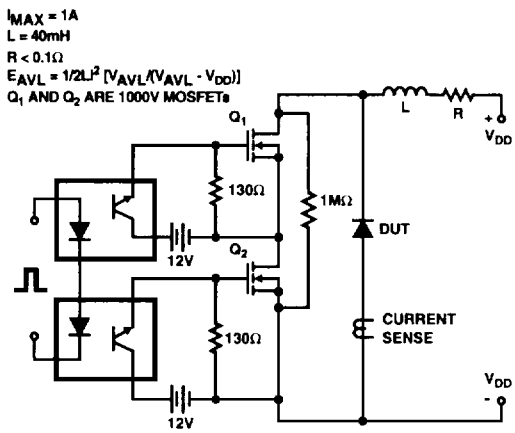


FIGURE 10. AVALANCHE ENERGY TEST CIRCUIT

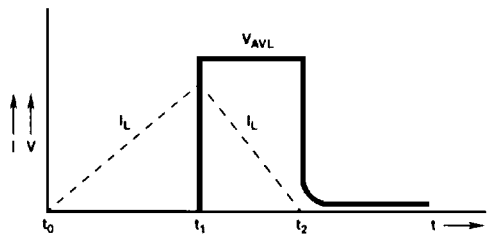


FIGURE 11. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS